

**Features**

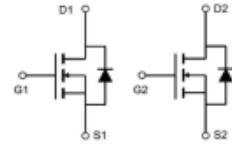
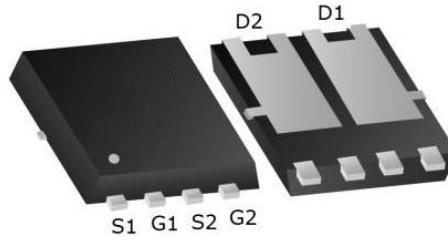
- Split Gate Trench MOSFET technology
- Excellent package for heat dissipation
- High density cell design for low  $R_{DS(ON)}$

**Product Summary**

| BVDSS | RDS(on) | ID  |
|-------|---------|-----|
| 60V   | 9mΩ     | 50A |

**Applications**

- DC-DC Converters
- Power management functions
- Synchronous-rectification applications

**PDFN5060-8L Pin Configuration****Absolute Maximum Ratings** ( $T_C=25^\circ\text{C}$  unless otherwise specified)

| Symbol         | Parameter                                       | Max.                      | Units                     |
|----------------|---|---------------------------|---------------------------|
| $V_{DSS}$      | Drain-Source Voltage                            | 60                        | V                         |
| $V_{GSS}$      | Gate-Source Voltage                             | $\pm 20$                  | V                         |
| $I_D$          | Continuous Drain Current                        | $T_C = 25^\circ\text{C}$  | A                         |
|                |   | $T_C = 100^\circ\text{C}$ | A                         |
| $I_{DM}$       | Pulsed Drain Current <sup>note1</sup>           | 180                       | A                         |
| $E_{AS}$       | Single Pulsed Avalanche Energy <sup>note2</sup> | 36                        | mJ                        |
| $P_D$          | Power Dissipation                               | $T_C = 25^\circ\text{C}$  | W                         |
| $R_{θJC}$      | Thermal Resistance, Junction to Case            | 2.5                       | $^\circ\text{C}/\text{W}$ |
| $T_J, T_{STG}$ | Operating and Storage Temperature Range         | -55 to +175               | $^\circ\text{C}$          |

**Electrical Characteristics** ( $T_J=25^\circ\text{C}$  unless otherwise specified)

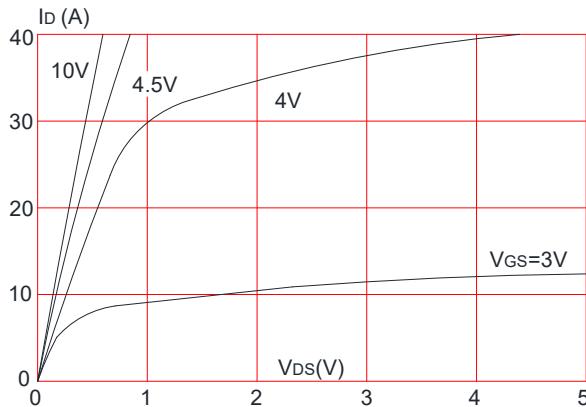
| Symbol  | Parameter  | Test Condition  | Min. | Typ. | Max.      | Units         |
|---|--|---|------|------|-----------|---------------|
| <b>Off Characteristic</b>                                     |  |   |      |      |           |               |
| $V_{(\text{BR})\text{DSS}}$                                   | Drain-Source Breakdown Voltage                           | $V_{GS}=0\text{V}$ , $I_D=250\mu\text{A}$   | 60   | -    | -         | V             |
| $I_{\text{DSS}}$  | Zero Gate Voltage Drain Current                          | $V_{DS}=60\text{V}$ , $V_{GS}=0\text{V}$ ,  | -    | -    | 1.0       | $\mu\text{A}$ |
| $I_{GSS}$   | Gate to Body Leakage Current                             | $V_{DS}=0\text{V}$ , $V_{GS}=\pm 20\text{V}$                                      | -    | -    | $\pm 100$ | nA            |
| <b>On Characteristics</b>                                     |  |   |      |      |           |               |
| $V_{GS(\text{th})}$   | Gate Threshold Voltage                                   | $V_{DS}=V_{GS}$ , $I_D=250\mu\text{A}$  | 1.0  | 1.6  | 2.5       | V             |
| $R_{DS(\text{on})}$<br>note3                                  | Static Drain-Source on-Resistance                        | $V_{GS}=10\text{V}$ , $I_D=20\text{A}$  | -    | 9    | 12        | mΩ            |
|   |  | $V_{GS}=4.5\text{V}$ , $I_D=10\text{A}$   | -    | 12   | 17        |               |
| <b>Dynamic Characteristics</b>                                |  |   |      |      |           |               |
| $C_{iss}$   | Input Capacitance  | $V_{DS}=25\text{V}$ , $V_{GS}=0\text{V}$ ,<br>$f=1.0\text{MHz}$                   | -    | 930  | -         | pF            |
| $C_{oss}$   | Output Capacitance                                       |   | -    | 230  | -         | pF            |
| $C_{rss}$   | Reverse Transfer Capacitance                             |   | -    | 8    | -         | pF            |
| $Q_g$   | Total Gate Charge  | $V_{DS}=30\text{V}$ , $I_D=20\text{A}$ ,<br>$V_{GS}=10\text{V}$                   | -    | 22   | -         | nC            |
| $Q_{gs}$  | Gate-Source Charge                                       |   | -    | 4.5  | -         | nC            |
| $Q_{gd}$  | Gate-Drain("Miller") Charge                              |   | -    | 3.5  | -         | nC            |
| <b>Switching Characteristics</b>                              |  |   |      |      |           |               |
| $t_{d(on)}$   | Turn-on Delay Time                                       | $V_{DD}=30\text{V}$ , $I_D=20\text{A}$ ,<br>$R_G=1.6\Omega$ , $V_{GS}=10\text{V}$ | -    | 4.5  | -         | ns            |
| $t_r$   | Turn-on Rise Time  |   | -    | 2.7  | -         | ns            |
| $t_{d(off)}$  | Turn-off Delay Time                                      |   | -    | 13.8 | -         | ns            |
| $t_f$   | Turn-off Fall Time                                       |   | -    | 2.7  | -         | ns            |
| <b>Drain-Source Diode Characteristics and Maximum Ratings</b> |  |   |      |      |           |               |
| $I_S$   | Maximum Continuous Drain to Source Diode Forward Current | -   | -    | 45   | -         | A             |
| $I_{SM}$  | Maximum Pulsed Drain to Source Diode Forward Current     | -   | -    | 180  | -         | A             |
| $V_{SD}$  | Drain to Source Diode Forward Voltage                    | $V_{GS}=0\text{V}$ , $I_S=30\text{A}$   | -    | -    | 1.2       | V             |
| $t_{rr}$  | Body Diode Reverse Recovery Time                         | $T_J=25^\circ\text{C}$ ,<br>$I_F=20\text{A}$ , $dI/dt=100\text{A}/\mu\text{s}$    | -    | 18   | -         | ns            |
| $Q_{rr}$  | Body Diode Reverse Recovery Charge                       |   | -    | 12   | -         | nC            |

Notes: 1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature

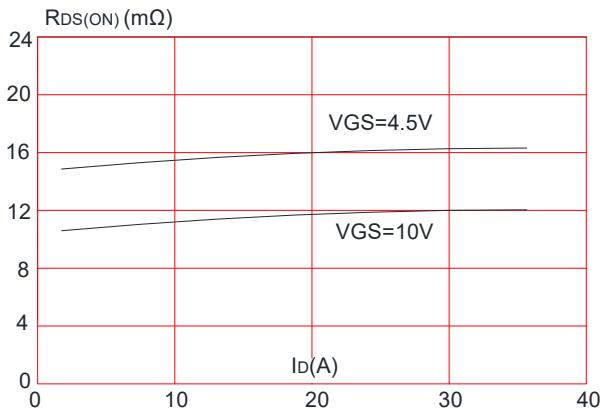
2. EAS condition:  $T_J=25^\circ\text{C}$ ,  $V_{DD}=30\text{V}$ ,  $V_G=10\text{V}$ ,  $R_G=25\Omega$ ,  $L=0.5\text{mH}$ ,  $I_{AS}=12\text{A}$ 3. Pulse Test: Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 0.5\%$

## Typical Performance Characteristics

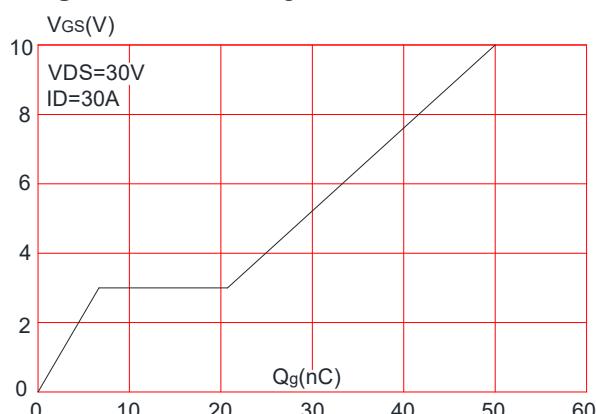
**Figure 1:** Output Characteristics



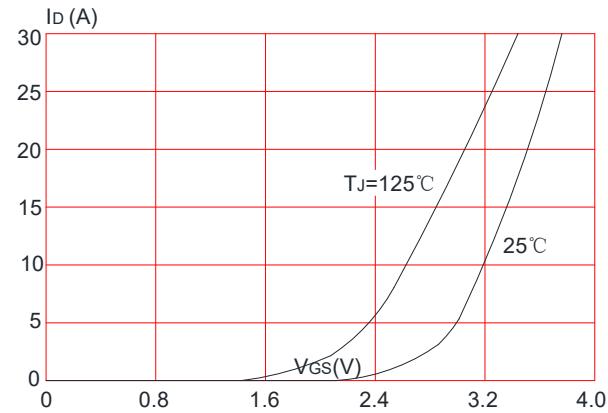
**Figure 3:** On-resistance vs. Drain Current



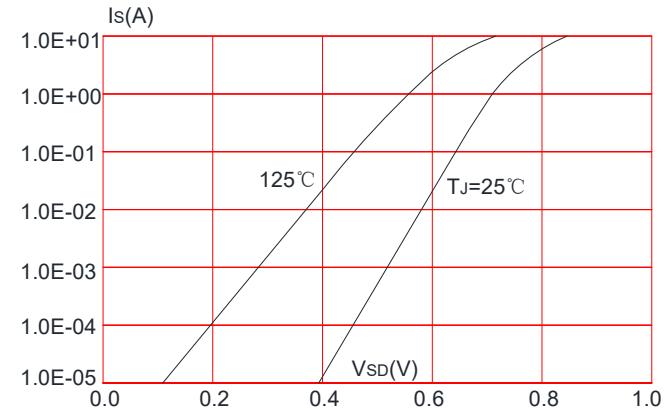
**Figure 5:** Gate Charge Characteristics



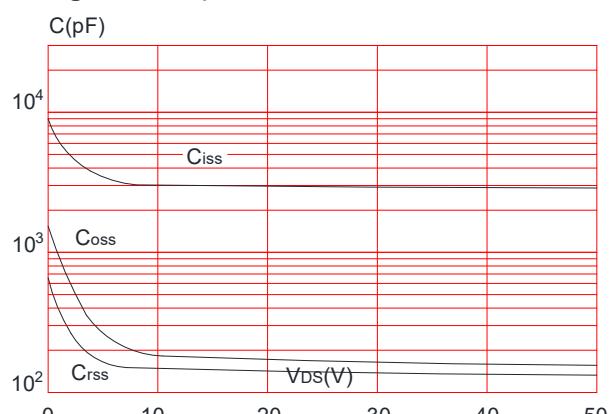
**Figure 2:** Typical Transfer Characteristics



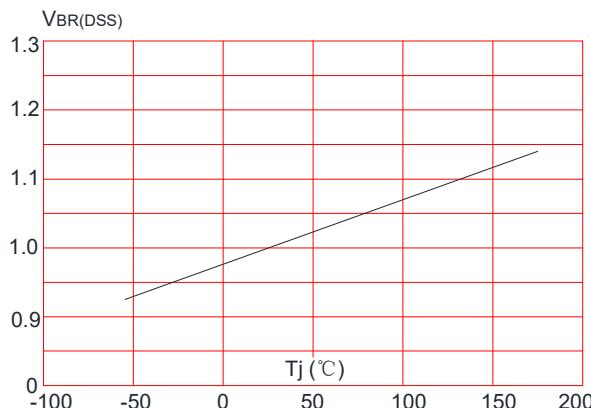
**Figure 4:** Body Diode Characteristics



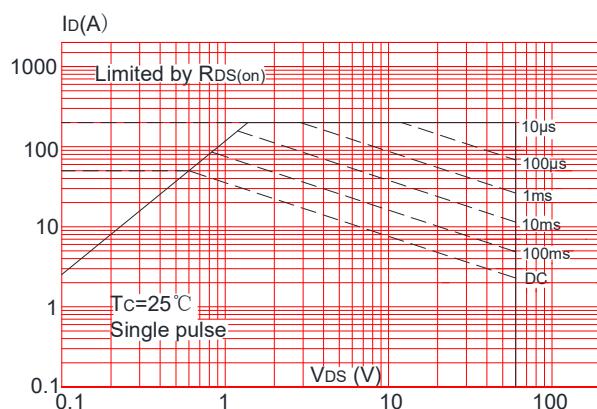
**Figure 6:** Capacitance Characteristics



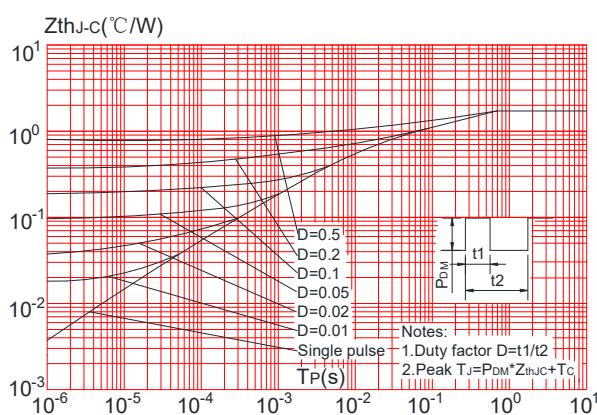
**Figure 7:** Normalized Breakdown Voltage vs. Junction Temperature



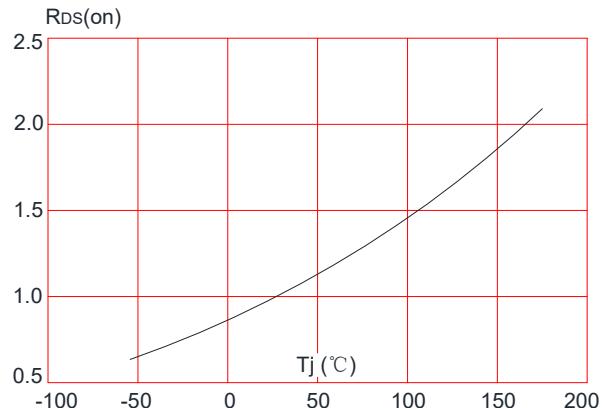
**Figure 9:** Maximum Safe Operating Area



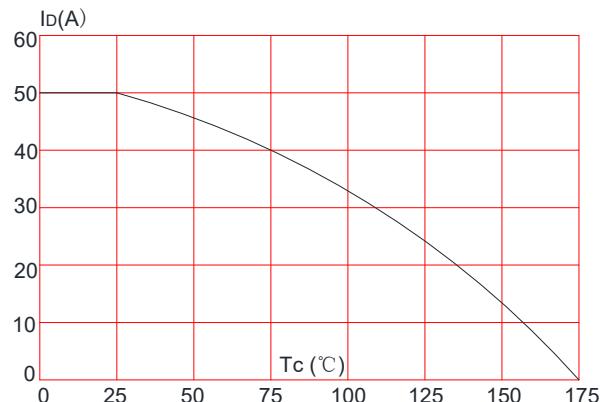
**Figure 11:** Maximum Effective Transient Thermal Impedance, Junction-to-Case



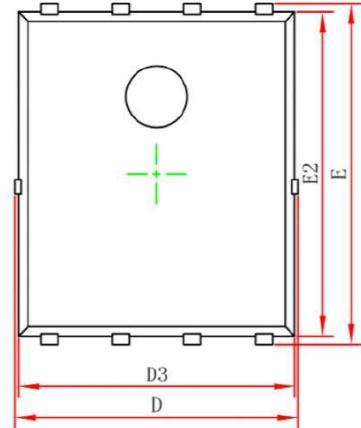
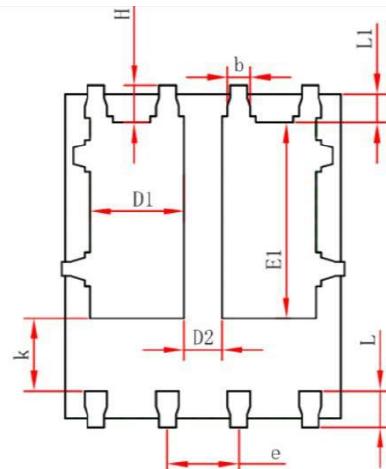
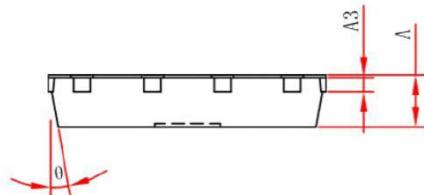
**Figure 8:** Normalized on Resistance vs. Junction Temperature



**Figure 10:** Maximum Continuous Drain Current vs. Case Temperature



## Package Mechanical Data- PDFN5X6-8L

Top ViewBottom ViewSide View

| Symbol | Dimensions In Millimeters |       | Dimensions In Inches |       |
|--------|---------------------------|-------|----------------------|-------|
|        | Min.                      | Max.  | Min.                 | Max.  |
| A      | 0.900                     | 1.000 | 0.035                | 0.039 |
| A3     | 0.154REF.                 |       | 0.006REF.            |       |
| D      | 4.944                     | 5.096 | 0.195                | 0.201 |
| E      | 5.974                     | 6.126 | 0.235                | 0.241 |
| D1     | 1.470                     | 1.870 | 0.058                | 0.074 |
| D2     | 0.470                     | 0.870 | 0.019                | 0.034 |
| E1     | 3.375                     | 3.575 | 0.133                | 0.141 |
| D3     | 4.824                     | 4.976 | 0.190                | 0.196 |
| E2     | 5.674                     | 5.826 | 0.223                | 0.229 |
| k      | 1.190                     | 1.390 | 0.047                | 0.055 |
| b      | 0.350                     | 0.450 | 0.014                | 0.018 |
| e      | 1.270TYP.                 |       | 0.050TYP.            |       |
| L      | 0.559                     | 0.711 | 0.022                | 0.028 |
| L1     | 0.424                     | 0.576 | 0.017                | 0.023 |
| H      | 0.574                     | 0.726 | 0.023                | 0.029 |
| θ      | 10°                       |       | 12°                  |       |